

AMENDMENTS TO THE CLAIMS

1. (Currently Amended) A method, comprising:
~~exciting an undesirable bond in an atomic layer deposition (ALD) formed film to an energy level greater than a ground state of the sufficient to activate the undesirable bond and insufficient to activate a desirable bond.~~
2. (Original) The method of claim 1, further comprising:
after exciting the undesirable bond, exposing the film to a reactant.
3. (Original) The method of claim 2, wherein the reactant is an oxygen source.
4. (Original) The method of claim 3, wherein the oxygen source is water.
5. (Original) The method of claim 2, wherein the reactant comprises a metal precursor.
6. (Original) The method of claim 5, wherein the metal is one of zirconium, titanium, aluminum, gallium, cesium, indium, hafnium, tantalum, praseodymium, niobium, scandium, lutetium, cerium and lanthanum.
7. (Original) The method of claim 1, wherein the undesirable bonds are metal-metal bonds.
8. (Original) The method of claim 7, wherein the metal is selected from a group consisting of zirconium, titanium, aluminum, gallium, cesium, indium, hafnium, tantalum, praseodymium, niobium, scandium, lutetium, cerium and lanthanum.
9. (Original) The method of claim 1, wherein the film is a metal oxide film.
10. (Original) The method of claim 1, wherein exciting the undesirable bonds comprises exposing the undesirable bonds to electromagnetic radiation.

11-20 (Canceled)

21. (Currently Amended) A method, comprising:
modifying undesirable bonds in an atomic layer deposition (ALD) formed film by
exciting the undesirable bond to an energy level greater than a ground state of the sufficient to
activate the undesirable bonds and insufficient to activate desirable bonds; and
exposing the film to a reactant.
22. (Original) The method of claim 21, wherein modifying the undesirable bonds comprises
reducing the number of undesirable bonds on the film.
23. (Original) The method of claim 21, wherein modifying the undesirable bonds comprises
minimizing the number of undesirable bonds on the film.